

FDT86246 N-Channel Power Trench[®] MOSFET 150 V, 2 A, 236 m Ω

Features

- Max $r_{DS(on)}$ = 236 m Ω at V_{GS} = 10 V, I_D = 2 A
- Max $r_{DS(on)}$ = 329 m Ω at V_{GS} = 6 V, I_D = 1.7 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant



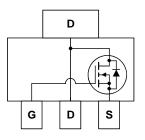
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Load Switch
- Primary Switch





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		150	V	
V _{GS}	Gate to Source Voltage		±20	V	
I _D	Drain Current -Continuous	(Note 1a)	2	Α	
	-Pulsed		8		
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	8	mJ	
Ĺ	Power Dissipation	(Note 1a)	2.2		
PD	Power Dissipation	(Note 1b)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

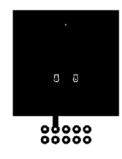
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	12	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	55	C/VV

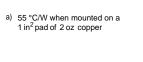
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86246	FDT86246	SOT-223	13 "	12 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		104		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μΑ	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	octeristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	3.1	4.0	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-9		mV/°C	
r _{DS(on)}		V _{GS} = 10 V, I _D = 2 A		194	236		
	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 1.7 A$		231	329	9 mΩ	
		$V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}, T_J = 125 \text{ °C}$		349	425		
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \ I_D = 2 \text{ A}$		5		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			161	215	pF	
		$V_{DS} = 75 V, V_{GS} = 0 V,$		161 21	215 30	pF pF	
C _{oss}	Input Capacitance	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		-	-		
C _{oss} C _{rss}	Input Capacitance Output Capacitance			21	30	pF	
C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance			21 1.6	30	pF pF	
C _{oss} C _{rss} R _g Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance			21 1.6	30	pF pF	
C _{oss} C _{rss} R _g Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics	f = 1 MHz		21 1.6 0.9	30 5	pF pF Ω	
C _{oss} C _{rss} Rg Switching t _{d(on)} t _r	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time			21 1.6 0.9 7.8	30 5 16	pF pF Ω ns	
C _{oss} C _{rss} R _g Switching t _{d(on)} t _r t _{d(off)}	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time	f = 1 MHz $V_{DD} = 75 \text{ V}, I_D = 2 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		21 1.6 0.9 7.8 2.3	30 5 16 10	pF pF Ω ns ns	
C _{oss} C _{rss} Rg Switching t _{d(on)} t _r t _{d(off)} t _f	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	f = 1 MHz $V_{DD} = 75 \text{ V}, I_D = 2 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		21 1.6 0.9 7.8 2.3 4.6	30 5 16 10 10	pF pF Ω ns ns ns	
C _{oss} C _{rss} Rg Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)}	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	f = 1 MHz $V_{DD} = 75 \text{ V}, I_D = 2 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		21 1.6 0.9 7.8 2.3 4.6 1.2	30 5 16 10 10 10	pF pF Ω ns ns ns ns	
C _{oss} C _{rss} Rg Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{g(TOT)}	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	f = 1 MHz		21 1.6 0.9 7.8 2.3 4.6 1.2 2.9	30 5 16 10 10 10 4	pF pF Ω ns ns ns ns	
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_{g} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ t_{r} \\ \hline \\ t_{d(off)} \\ \hline \\ t_{f} \\ \hline \\ Q_{g(TOT)} \\ \hline \\ Q_{gs} \\ \hline \\ Q_{gd} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	f = 1 MHz $V_{DD} = 75 \text{ V}, I_D = 2 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		21 1.6 0.9 7.8 2.3 4.6 1.2 2.9 1.7	30 5 16 10 10 10 4	pF pF Ω ns ns ns nC	
Coss Crss Rg Switching td(on) tr dg(TOT) Qg(TOT) Qgs Qgd	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Total Gate Charge	f = 1 MHz $V_{DD} = 75 \text{ V}, I_D = 2 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		21 1.6 0.9 7.8 2.3 4.6 1.2 2.9 1.7 0.9	30 5 16 10 10 10 4	pF pF Ω ns ns ns nc	
Coss Crss Rg Switching \$\$t_{d(on)}\$ tr \$\$t_{d(off)}\$ \$\$t_{f}\$ \$\$Q_{g(TOT)}\$ \$\$Q_{gs}\$ \$\$Q_{gd}\$ \$\$Drain-Soil	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge	f = 1 MHz $V_{DD} = 75 \text{ V}, I_D = 2 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		21 1.6 0.9 7.8 2.3 4.6 1.2 2.9 1.7 0.9	30 5 16 10 10 10 4	pF pF Ω ns ns ns nc nC	
$\begin{array}{c} C_{oss} \\ \hline C_{rss} \\ \hline R_g \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline t_r \\ \hline t_q \\ \hline \textbf{t}_{d(off)} \\ \hline t_f \\ \hline \textbf{Q}_{g(TOT)} \\ \hline \textbf{Q}_{g(TOT)} \\ \hline \textbf{Q}_{gs} \\ \hline \textbf{Q}_{gd} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$ \begin{array}{c} f = 1 \text{ MHz} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$		21 1.6 0.9 7.8 2.3 4.6 1.2 2.9 1.7 0.9 0.8	30 5 16 10 10 10 4 3	pF pF Ω ns ns ns nc nC nC	

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.





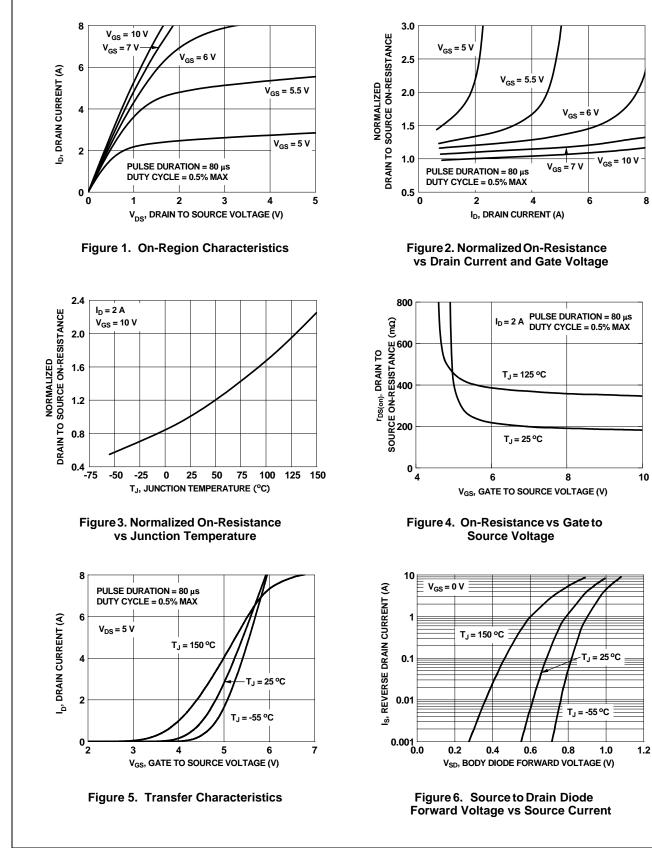


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b) 118 °C/W when mounted on a minimum pad of 2 oz copper

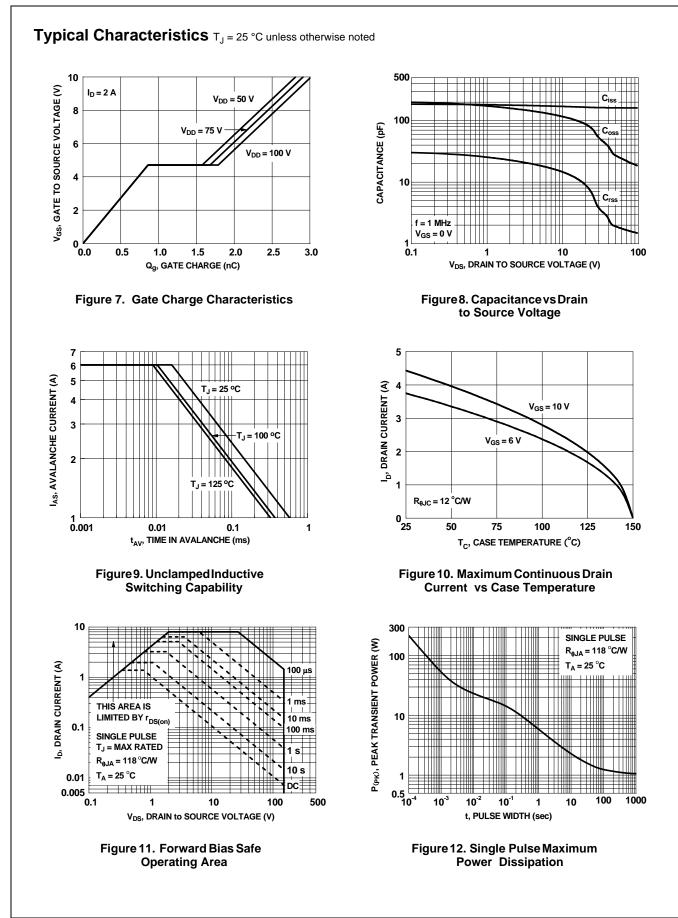
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25 °C; N-ch: L = 1.0 mH, I_{AS} = 4.0 A, V_{DD} = 135 V, V_{GS} = 10 V.



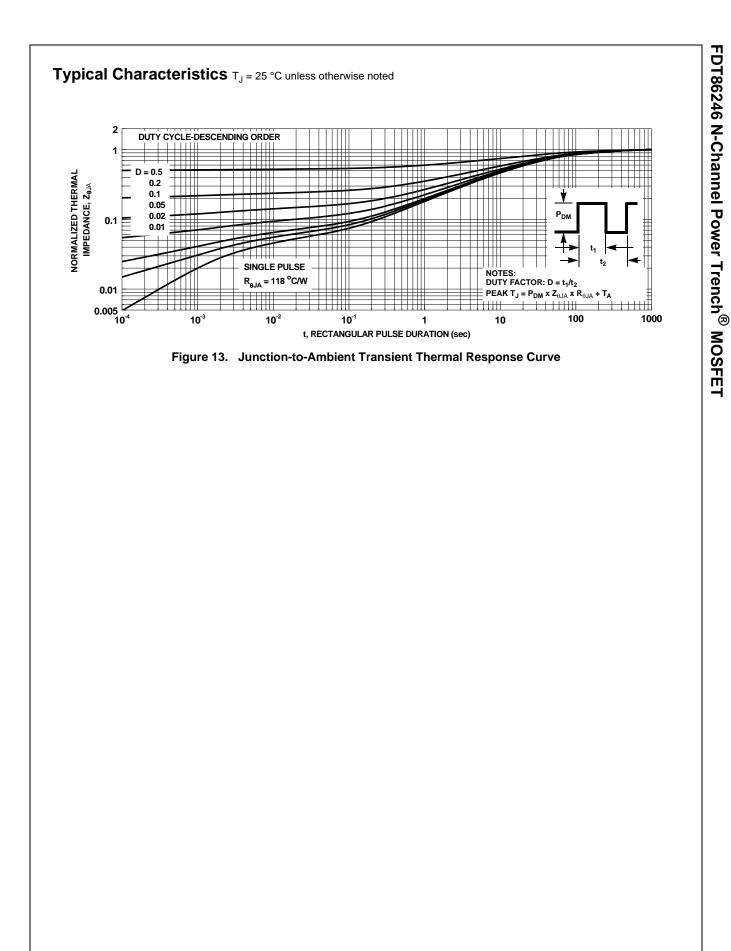
Typical Characteristics T_J = 25 °C unless otherwise noted

FDT86246 N-Channel Power Trench[®] MOSFET



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4





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